N-CHANNEL ENHANCEMENT MODE POWER MOSFET

● General Description

The 4410 combines advanced trench MOSFET technology with a low resistance package to provide extremely low RDS(ON). This device is ideal for load switch and battery protection applications.

● Features

Advance high cell density Trench technology

Low RDS(ON) to minimize conductive loss

Low Gate Charge for fast switching

Dual DIE in one package

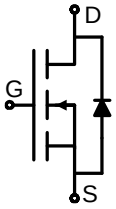
●Application

Power Management in Notebook Computer,

Portable Equipment and Battery

Powered Systems

● Product Summary

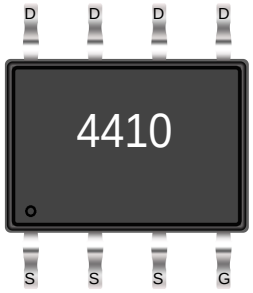


V_{DS} =30V I_D =15A

$R_{DSON(10V\ typ)}$ =8.3mΩ

$R_{DSON(4.5V\ typ)}$ =10.0mΩ

RoHS compliant



SOP-8

●Package Marking and Ordering Information:

Part NO.	4410
Basic ordering unit (pcs)	4000

●Absolute Maximum Ratings (T_C =25℃)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	$I_{D@}$TC=25℃	15	A
	$I_{D@}$TC=75℃	11	A
	$I_{D@}$TC=100℃	9.0	A
Pulsed Drain Current ①	I_{DM}	45	A
Total Power Dissipation	P_D@TC=25℃	35	W
Total Power Dissipation	P_D@TA=25℃	0.8	W
Operating Junction Temperature	T_J	-55 to 150	℃
Storage Temperature	T_{STG}	-55 to 150	℃
Single Pulse Avalanche Energy	E_{AS}	35	mJ

●Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}	-	-	4.5	° C/W
Thermal resistance, junction - ambient	R_{thJA}	-	-	60	° C/W
Soldering temperature, wavesoldering for 8 s	T_{sold}	-	-	265	° C

●Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS} =0V,I_D =250uA	30	-	-	V
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} =V_{DS}, I_D =250uA	1.2	1.5	2.5	V
Drain-Source Leakage Current	I_{DSS}	V_{DS}=30 V_{GS} =0V	-	-	1.0	uA
Gate- Source Leakage Current	I_{GSS}	V_{GS}=±20V ,V_{DS} =0V	-	-	±100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=15A	-	8.3	10	mΩ
		V_{GS}=4.5V, I_D=10A	-	10	15	mΩ
Forward Transconductance	g_{FS}	V_{DS} =25V, I_D=10A	-	8	-	S
Source-drain voltage	V_{SD}	Is=10A	-	-	1.20	V

●Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	Ciss	f = 1MHz V_{DS}=15V V_{GS}=0V	-	1007	-	pF
Output capacitance	Coss		-	128.9	-	
Reverse transfer capacitance	Crss		-	117.7	-	

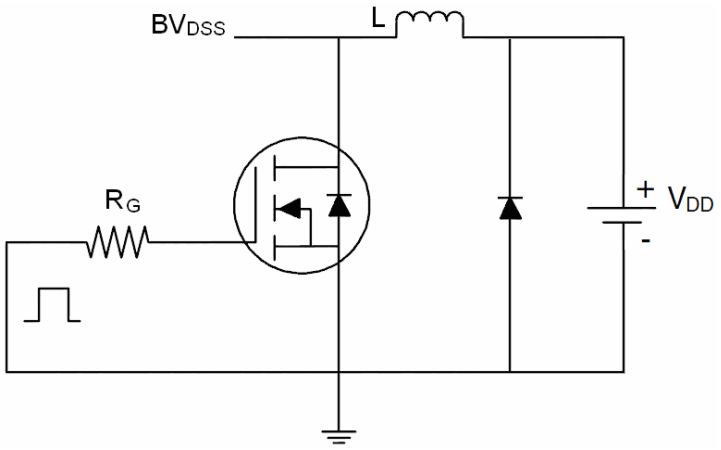
●Gate Charge characteristics(T_a = 25℃)

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Qg	V_{DD} = 15V I_D = 10A V_{GS} = 10V	-	23.1	-	nC
Gate - Source charge	Qgs		-	4.28	-	
Gate - Drain charge	Qgd		-	4.32	-	

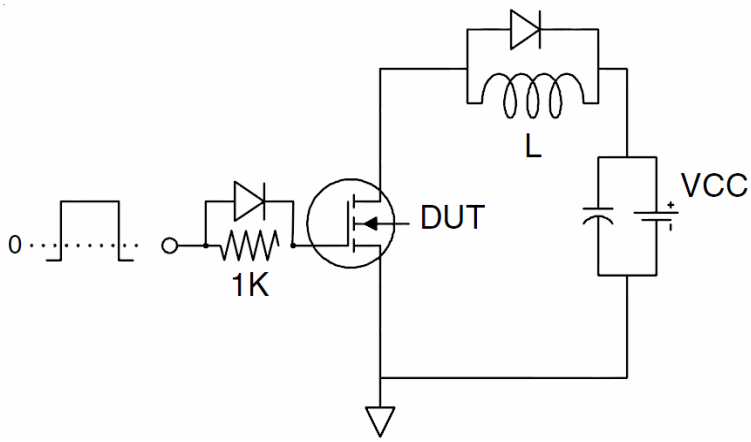
Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;

Test Circuit

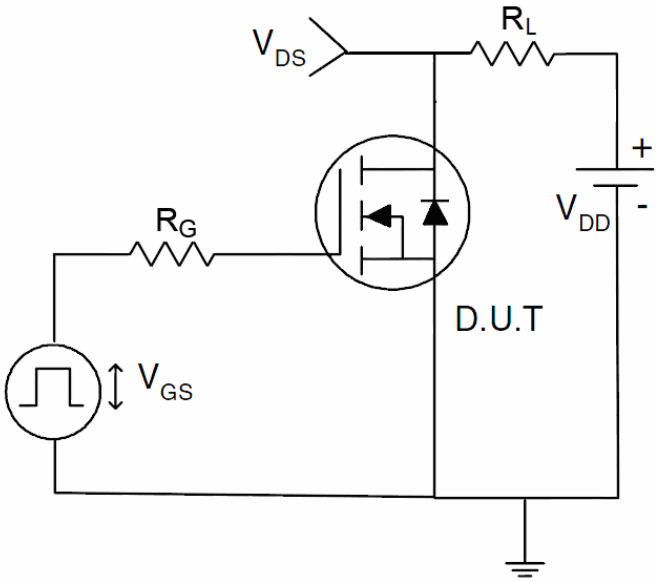
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics

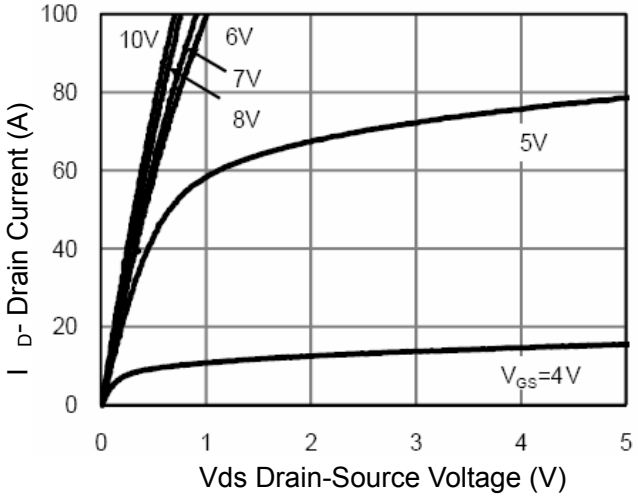


Figure 1 Output Characteristics

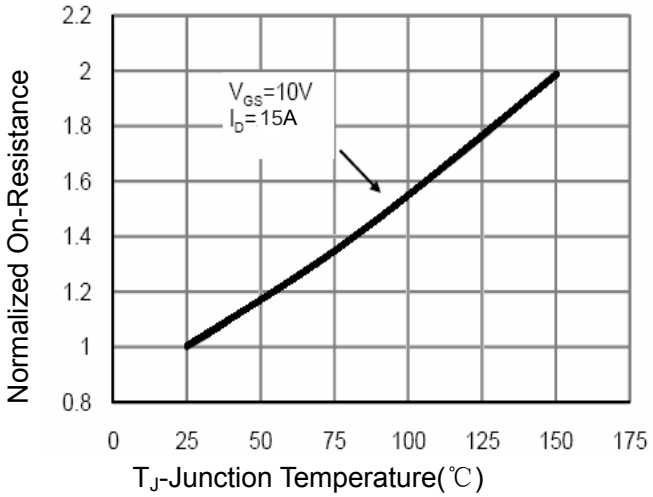


Figure 4 Rdson-JunctionTemperature

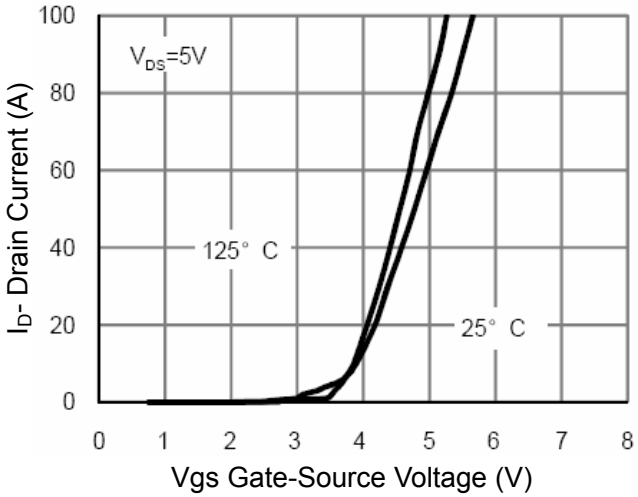


Figure 2 Transfer Characteristics

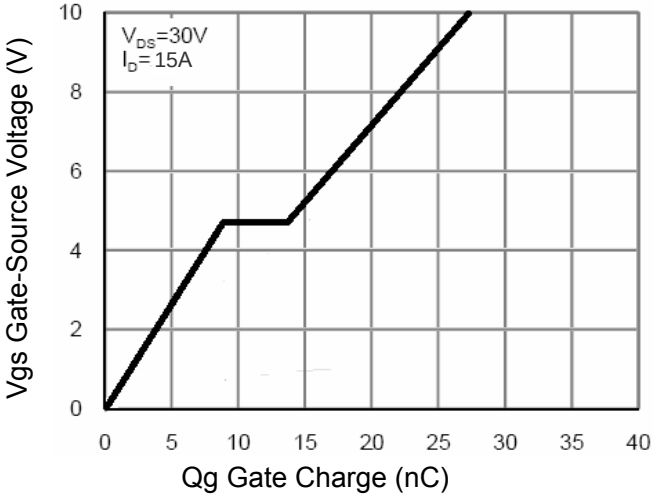


Figure 5 Gate Charge

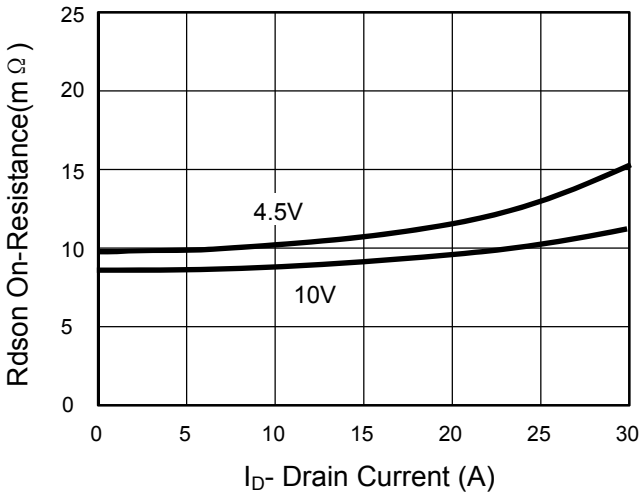


Figure 3 Rdson- Drain Current

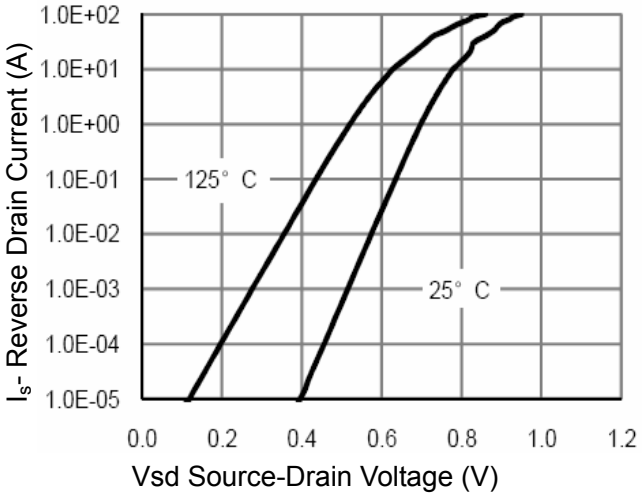


Figure 6 Source- Drain Diode Forward

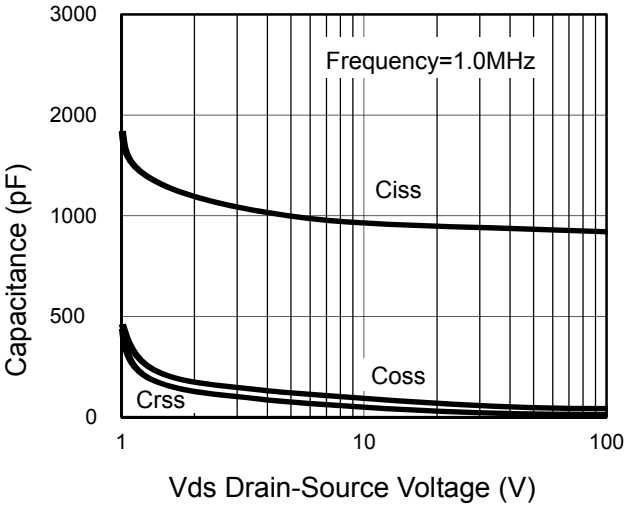


Figure 7 Capacitance vs Vds

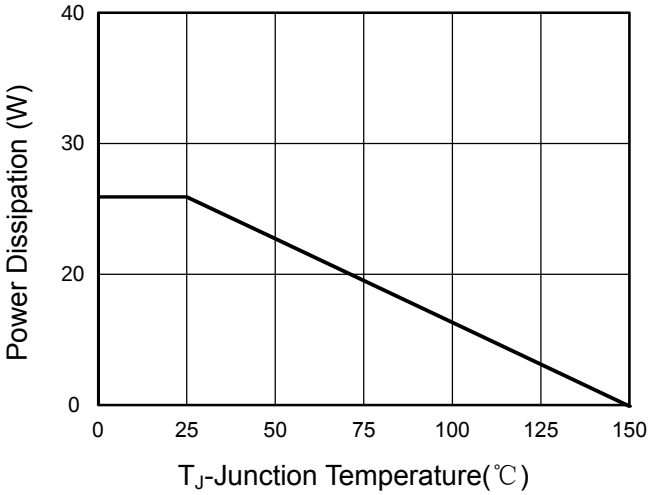


Figure 9 Power De-rating

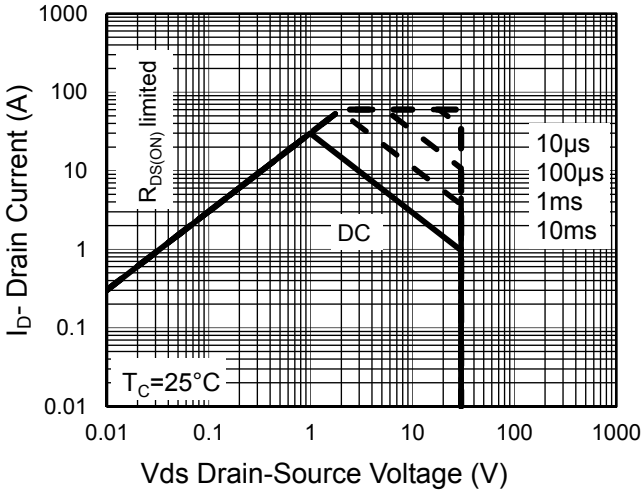


Figure 8 Safe Operation Area

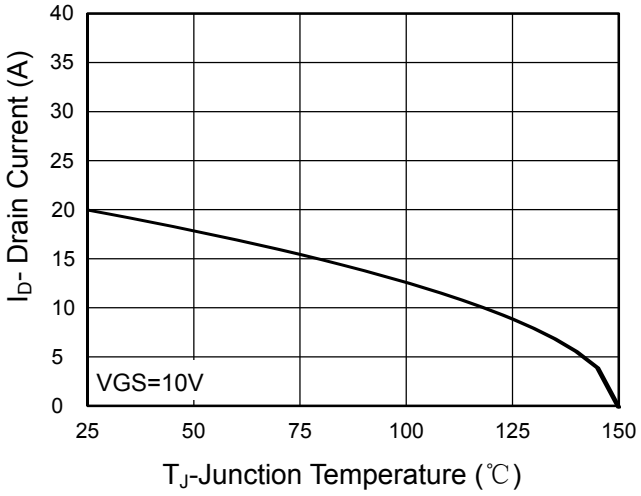


Figure 10 Current De-rating

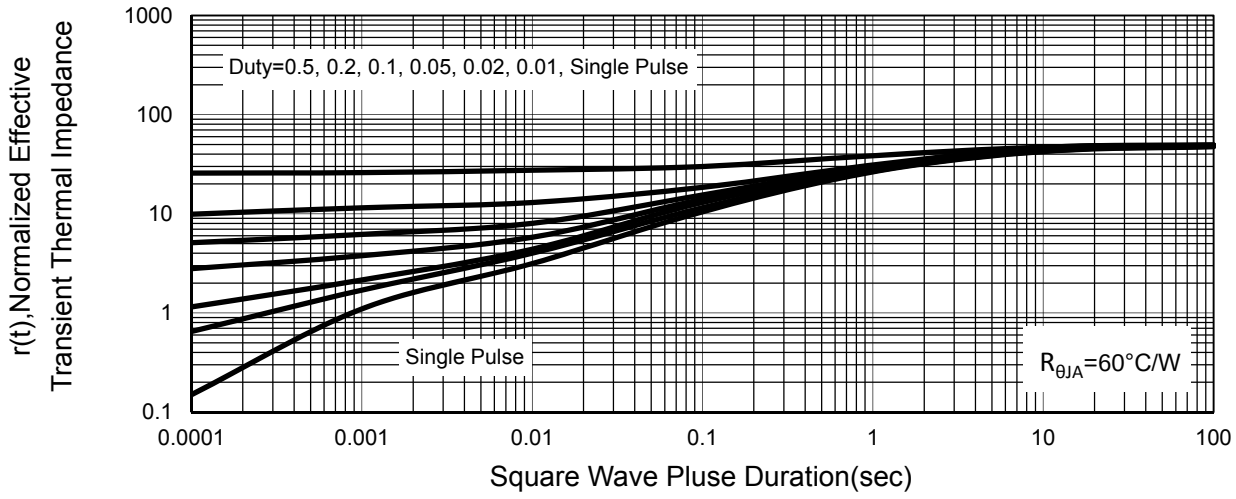
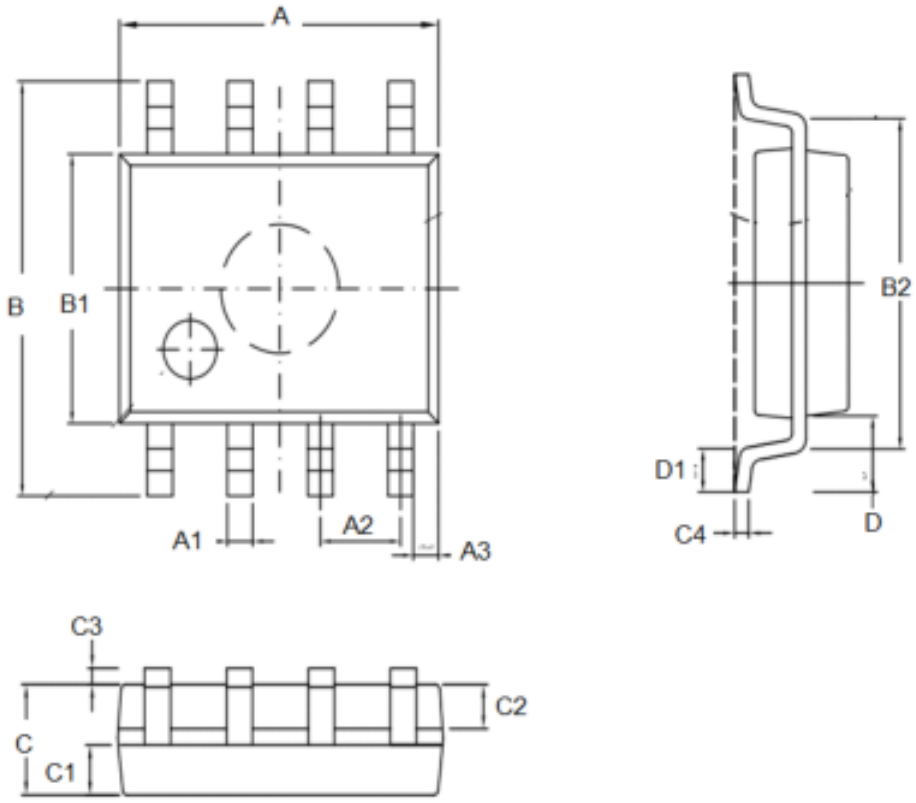


Figure 11 Normalized Maximum Transient Thermal Impedance

SOP-8 Package Outline Dimensions



Unit: mm

SYMBOL	min	TYP	max	SYMBOL	min		max
A	4.80		5.25	C	1.30		1.75
A1	0.37		0.49	C1	0.55		0.75
A2		1.27		C2	0.55		0.65
A3		0.41		C3	0.05		0.20
B	5.80		6.20	C4	0.10	0.20	0.23
B1	3.80		4.10	D		1.05	
B2		5.00		D1	0.40		0.62

Note:
1.Controlling dimension:in millimeters.
2.General tolerance:±0.05mm.
3.The pad layout is for reference purposes only.

单击下面可查看定价，库存，交付和生命周期等信息

>>KUU(永裕泰)